

16-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

Check for Samples: SN74LVC16T245-EP

| FEATURES | |
|---|---|
| Control Inputs V_{IH} and V_{IL} Levels Are Referenced to V_{CCA} Voltage | DGG PACKAGE (TOP VIEW) |
| V_{CC} Isolation Feature – If Either V_{CC} Input Is at | |
| GND, Both Ports Are in the High-Impedance | 1B1 🛛 2 🛛 47 🗋 1A1 |
| State | 1B2 3 46 1A2 |
| Overvoltage-Tolerant Inputs and Outputs | GND 4 45 GND |
| Allow Mixed-Voltage-Mode Data | 1B3 5 44 1A3 |
| Communications | |
| Fully Configurable Dual-Rail Design Allows | V _{CCB} 7 42 V _{CCA} |
| Each Port to Operate Over the Full 1.65-V to | |
| 5.5-V Power-Supply Range | 1B6 9 40 1A6 GND 10 39 GND |
| I_{off} Supports Partial-Power-Down Mode | |
| Operation | 1B8 [12 37] 1A8 |
| Latch-Up Performance Exceeds 100 mA Per | 2B1 [13 36] 2A1 |
| JESD 78, Class II | 2B2 [14 35] 2A2 |
| ESD Protection Exceeds JESD 22 | GND 15 34 GND |
| 2000-V Human-Body Model (A114-A) | 2B3 16 33 2A3 |
| 200-V Machine Model (A115-A) | 2B4 🛛 17 32 🗍 2A4 |
| 1000-V Charged-Device Model (C101) | V _{CCB} [18 31] V _{CCA} |
| looo V ollargoa Dovido modol (ollor) | 2B5 [19 30] 2A5 |
| SUPPORTS DEFENSE, AEROSPACE, | 2B6 🛛 20 29 🗋 2A6 |
| AND MEDICAL APPLICATIONS | GND 21 28 GND |
| Controlled Baseline | 2B7 🛛 22 27 🛛 2A7 |
| | 2B8 23 26 2A8 |
| One Assembly and Test Site | 2DIR 🛛 24 25 🛛 2 0E |

- One Fabrication Site
- Available in Military (-55°C to 125°C) Temperature Ranges ⁽¹⁾
- Extended Product Life Cycle
- Extended Product-Change Notification
- Product Traceability

(1) Custom temperature ranges available

DESCRIPTION

This 16-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.65 V to 5.5 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.65 V to 5.5 V. This allows for universal low-voltage bidirectional translation between any of the 1.8-V, 2.5-V, 3.3-V, and 5-V voltage nodes.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013

DESCRIPTION (CONTINUED)

The SN74LVC16T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ}.

The SN74LVC16T245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Table 1. ORDERING INFORMATION⁽¹⁾

| T _A | PACKA | GE | ORDERABLE PART NUMBER | TOP-SIDE MARKING | VID NUMBER |
|----------------|-----------|--------------|--------------------------|------------------|------------------|
| 55°C to 125°C | | Reel of 2000 | CLVC16T245MDGGREP | | V62/12667-01XE |
| –55°C to 125°C | TSSOP-DGG | Tube of 40 | CLVC16T245MDGGEP | LVC16T245M | V62/12667-01XE-T |

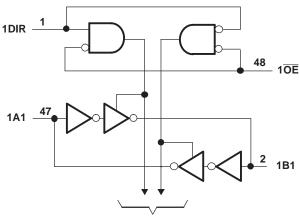
(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

FUNCTION TABLE⁽¹⁾ (EACH 8-BIT SECTION)

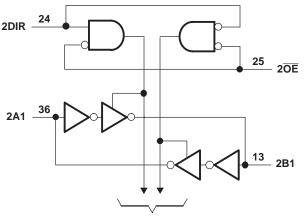
| CONTRO | L INPUTS | OUTPUT C | IRCUITS | |
|--------|----------|----------|---------------|-----------------|
| OE | DIR | A PORT | B PORT | OPERATION |
| L | L | Enabled | Hi-Z | B data to A bus |
| L | Н | Hi-Z | Enabled | A data to B bus |
| н | Х | Hi-Z | Hi-Z | Isolation |

(1) Input circuits of the data I/Os always are active.

LOGIC DIAGRAM (POSITIVE LOGIC)



To Seven Other Channels



To Seven Other Channels

TEXAS INSTRUMENTS

SCES843A - JANUARY 2013 - REVISED FEBRUARY 2013

www.ti.com

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------------------------|--|--------------------|--------|----------------------|------|
| V _{CCA} V _{CCB} | Supply voltage range | | -0.5 | 6.5 | V |
| | | I/O ports (A port) | -0.5 | 6.5 | |
| VI | Input voltage range ⁽²⁾ | I/O ports (B port) | -0.5 | 6.5 | V |
| | | Control inputs | -0.5 | 6.5 | |
| V | Voltage range applied to any output | A port | -0.5 | 6.5 | V |
| Vo | in the high-impedance or power-off state ⁽²⁾ | B port | -0.5 | -0.5 6.5 | |
| V | Voltage range applied to any output in the high or law state $\binom{2}{3}$ | A port | -0.5 V | _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state $^{(2)}$ $^{(3)}$ | B port | -0.5 V | _{ССВ} + 0.5 | v |
| I _{IK} | Input clamp current | V ₁ < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| lo | Continuous output current | | | ±50 | mA |
| | Continuous current through each V _{CCA} , V _{CCB} , and GND | | | ±100 | mA |
| TJ | Maximum junction temperature | | | 150 | °C |
| T _{stg} | Storage temperature range | | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The output positive-voltage rating may be exceeded up to 6.5 V maximum if the output current rating is observed.

THERMAL INFORMATION

| | | SN74LVC16T245 | |
|--------------------|---|---------------|-------|
| | THERMAL METRIC ⁽¹⁾ | DGG | UNITS |
| | | 48 PINS | |
| θ_{JA} | Junction-to-ambient thermal resistance ⁽²⁾ | 59.9 | |
| θ _{JCtop} | Junction-to-case (top) thermal resistance ⁽³⁾ | 13.9 | |
| θ_{JB} | Junction-to-board thermal resistance ⁽⁴⁾ | 27.1 | °C/W |
| Ψ_{JT} | Junction-to-top characterization parameter ⁽⁵⁾ | 0.5 | °C/W |
| Ψ _{JB} | Junction-to-board characterization parameter ⁽⁶⁾ | 26.8 | |
| θ_{JCbot} | Junction-to-case (bottom) thermal resistance ⁽⁷⁾ | N/A | |

(1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, SPRA953.

(2) The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a JEDEC-standard, high-K board, as specified in JESD51-7, in an environment described in JESD51-2a.

(3) The junction-to-case (top) thermal resistance is obtained by simulating a cold plate test on the package top. No specific JEDECstandard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

(4) The junction-to-board thermal resistance is obtained by simulating in an environment with a ring cold plate fixture to control the PCB temperature, as described in JESD51-8.

(5) The junction-to-top characterization parameter, ψ_{JT} , estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining θ_{JA} , using a procedure described in JESD51-2a (sections 6 and 7).

(6) The junction-to-board characterization parameter, ψ_{JB} , estimates the junction temperature of a device in a real system and is extracted from the simulation data for obtaining θ_{JA} , using a procedure described in JESD51-2a (sections 6 and 7).

(7) The junction-to-case (bottom) thermal resistance is obtained by simulating a cold plate test on the exposed (power) pad. No specific JEDEC standard test exists, but a close description can be found in the ANSI SEMI standard G30-88.

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013

www.ti.com

STRUMENTS

XAS

Recommended Operating Conditions⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|------------------------------|--|------------------|------------------|-------------------------|-------------------------|------|
| V _{CCA} | Supply voltogo | | | | 1.65 | 5.5 | V |
| V _{CCB} | Supply voltage | | | | 1.65 | 5.5 | V |
| | | | 1.65 V to 1.95 V | | V _{CCI} × 0.65 | | |
| . / | High-level | Deta incuta (5) | 23 \/ to 27 \/ | | | | |
| VIH | input voltage | Data inputs ⁽⁵⁾ | 3 V to 3.6 V | | 2 | | V |
| | | | 4.5 V to 5.5 V | | V _{CCI} × 0.7 | | |
| | | | 1.65 V to 1.95 V | | | V _{CCI} × 0.35 | |
| . , | Low-level | D ((5) | 2.3 V to 2.7 V | | | 0.7 | |
| VIL | input voltage | Data inputs ⁽⁵⁾ | 3 V to 3.6 V | | | 0.8 | V |
| | | | 4.5 V to 5.5 V | | | $V_{CCI} \times 0.3$ | |
| | | | 1.65 V to 1.95 V | | $V_{CCA} \times 0.65$ | | |
| ., | High-level | Control inputs | 2.3 V to 2.7 V | | 1.7 | | ., |
| V _{IH} | input voltage | (referenced to V_{CCA}) ⁽⁶⁾ | 3 V to 3.6 V | | 2 | | V |
| | | | 4.5 V to 5.5 V | | $V_{CCA} \times 0.7$ | | |
| | | | 1.65 V to 1.95 V | | | $V_{CCA} \times 0.35$ | |
| ., | Low-level | Control inputs | 2.3 V to 2.7 V | | | 0.7 | ., |
| V _{IL} | input voltage (referenced to | (referenced to V_{CCA}) ⁽⁶⁾ | 3 V to 3.6 V | | | 0.8 | V |
| | | | 4.5 V to 5.5 V | | | $V_{CCA} \times 0.3$ | |
| VI | Input voltage | Control inputs | | | 0 | 5.5 | V |
| . <i>,</i> | | Active state | | | 0 | V _{cco} | |
| V _{I/O} | Input/output voltage | 3-State | | | 0 | 5.5 | V |
| | | | | 1.65 V to 1.95 V | | -4 | |
| | | | | 2.3 V to 2.7 V | | -8 | |
| I _{ОН} | High-level output cur | rent | | 3 V to 3.6 V | | -24 | mA |
| | | | | 4.5 V to 5.5 V | | -32 | |
| | | | | 1.65 V to 1.95 V | | 4 | |
| | | | | 2.3 V to 2.7 V | | 8 | |
| I _{OL} | Low-level output curr | ent | | 3 V to 3.6 V | | 24 | mA |
| | | | | 4.5 V to 5.5 V | | 32 | |
| | | | 1.65 V to 1.95 V | | | 20 | |
| | Input transition | | 2.3 V to 2.7 V | | | 20 | |
| Δt/Δv | rise or fall rate | but transition e or fall rate Data inputs | 3 V to 3.6 V | | | 10 | ns/V |
| | | | 4.5 V to 5.5 V | | | 5 | |
| T _A | Operating free-air ter | nperature | | | -55 | 125 | °C |

(1) V_{CCI} is the V_{CC} associated with the input port.

(2) V_{CCO} is the V_{CC} associated with the output port. (3) All unused or driven (floating) data inputs (I/Os) of the device must be held at logic HIGH or LOW (preferably V_{CCI} or GND) to ensure proper device operation and minimize power. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

- (4) All unused data inputs of the device must be held at V_{CCA} or GND to ensure proper device operation. (5) For V_{CCI} values not specified in the data sheet, V_{IH} min = $V_{CCI} \times 0.7$ V, V_{IL} max = $V_{CCI} \times 0.3$ V. (6) For V_{CCA} values not specified in the data sheet, V_{IH} min = $V_{CCA} \times 0.7$ V, V_{IL} max = $V_{CCA} \times 0.3$ V.

SCES843A - JANUARY 2013 - REVISED FEBRUARY 2013

www.ti.com

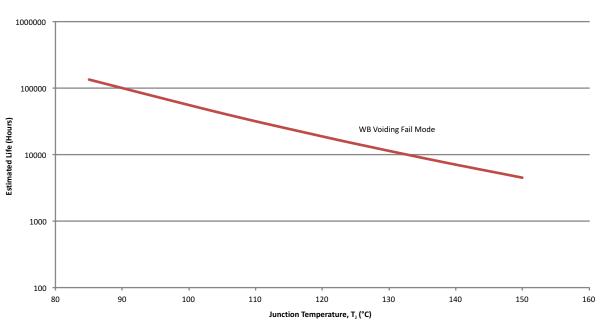
Electrical Characteristics⁽¹⁾⁽²⁾

 $T_A = -55^{\circ}C$ to 125°C, over recommended input voltage range (unless otherwise noted)

| PAF | RAMETER | TEST CONDITIONS | V _{CCA} | V _{CCB} | MIN | TYP | MAX | UNIT |
|--------------------|----------------|---|------------------|------------------|------------------------|-----|------|------|
| | | $I_{OH} = -100 \ \mu A, \qquad V_I = V_{IH}$ | 1.65 V to 4.5 V | 1.65 V to 4.5 V | V _{CCO} - 0.1 | | | |
| | | $I_{OH} = -4 \text{ mA}, \qquad V_I = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | |
| V _{он} | | $I_{OH} = -8 \text{ mA}, \qquad V_I = V_{IH}$ | 2.3 V | 2.3 V | 1.9 | | | V |
| | | $I_{OH} = -24 \text{ mA}, \qquad V_I = V_{IH}$ | 3 V | 3 V | 2.35 | | | |
| | | $I_{OH} = -32 \text{ mA}, \qquad V_I = V_{IH}$ | 4.5 V | 4.5 V | 3.75 | | | |
| | | $I_{OL} = 100 \ \mu A, \qquad V_I = V_{IL}$ | 1.65 V to 4.5 V | 1.65 V to 4.5 V | | | 0.1 | |
| | | $I_{OL} = 4 \text{ mA}, \qquad V_I = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | |
| V _{OL} | | $I_{OL} = 8 \text{ mA}, \qquad V_I = V_{IL}$ | 2.3 V | 2.3 V | | | 0.3 | V |
| | | $I_{OL} = 24 \text{ mA}, \qquad V_I = V_{IL}$ | 3 V | 3 V | | | 0.65 | |
| | | $I_{OL} = 32 \text{ mA}, \qquad V_I = V_{IL}$ | 4.5 V | 4.5 V | | | 0.65 | |
| I | Control inputs | $V_{I} = V_{CCA}$ or GND | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | ±2 | μA |
| | A or B | | 0 V | 0 to 5.5 V | | | ±10 | |
| off | port | $V_{\rm I}$ or $V_{\rm O}$ = 0 to 5.5 V | 0 to 5.5 V | 0 V | = | | | μA |
| oz | A or B port | $\frac{V_{O}}{OE} = V_{CCO} \text{ or GND},$ $\overline{OE} = V_{IH}$ | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | ±10 | μA |
| | L. | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | 20 | |
| CCA | | $V_{I} = V_{CCI}$ or GND, $I_{O} = 0$ | 5 V | 0 V | | | 20 | μA |
| | | 10 - 0 | 0 V | 5 V | | | -2.5 | |
| | | | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | 20 | |
| ССВ | | $V_{I} = V_{CCI}$ or GND, $I_{O} = 0$ | 5 V | 0 V | | | -2.5 | μA |
| | | 0 - 0 | 0 V | 5 V | | | 20 | |
| _{CCA} + I | ССВ | $V_{I} = V_{CCI}$ or GND, $I_{O} = 0$ | 1.65 V to 5.5 V | 1.65 V to 5.5 V | | | 30 | μA |
| | A port | One A port at V _{CCA} $-$ 0.6 V, DIR at V _{CCA} , B port = open | | | | | 50 | |
| ∆I _{CCA} | DIR | DIR at $V_{CCA} - 0.6 V$, B port = open, A port at V_{CCA} or GND | 3 V to 5.5 V | 3 V to 5.5 V | | 50 | | μA |
| 7I ^{CCB} | B port | One B port at $V_{CCB} - 0.6 V$, DIR at GND, A port = open | 3 V to 5.5 V | 3 V to 5.5 V | | | 50 | μA |
| Ci | Control inputs | $V_1 = V_{CCA}$ or GND | 3.3 V | 3.3 V | | 4 | | pF |
| Cio | A or B port | $V_{O} = V_{CCA/B}$ or GND | 3.3 V | 3.3 V | | 8.5 | | pF |
| | | | | 4 | 4 | | | |

 $\begin{array}{ll} \mbox{(1)} & V_{CCO} \mbox{ is the } V_{CC} \mbox{ associated with the output port.} \\ \mbox{(2)} & V_{CCI} \mbox{ is the } V_{CC} \mbox{ associated with the input port.} \end{array}$

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013



(1) See datasheet for absolute maximum and minimum recommended operating conditions.





SCES843A - JANUARY 2013 - REVISED FEBRUARY 2013

www.ti.com

Switching Characteristics

 $T_A = -40^{\circ}$ C to 85°C, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM | TO | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | | _{CB} = 5 V ± 0.5 V U | |
|------------------|---------|----------|-----------------------------|------|-----------------------------|------|-----------------------------|------|-----|----------------------------------|-----|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | А | В | 1.7 | 21.9 | 1.3 | 9.2 | 1 | 7.4 | 0.8 | 7.1 | ns |
| t _{PHL} | A | В | 1.7 | 21.9 | 1.5 | 9.2 | I | 7.4 | 0.8 | 7.1 | 115 |
| t _{PLH} | В | А | 0.9 | 23.8 | 0.8 | 23.6 | 0.7 | 23.4 | 0.7 | 23.4 | ns |
| t _{PHL} | В | ~ | 0.9 | 23.0 | 0.8 | 23.0 | 0.7 | 23.4 | 0.7 | 23.4 | 115 |
| t _{PHZ} | OE | А | 1.6 | 29.6 | 1.5 | 29.4 | 1.5 | 29.3 | 1.4 | 29.2 | ns |
| t _{PLZ} | OL | A | 1.0 | 29.0 | 1.5 | 29.4 | 1.5 | 23.5 | 1.4 | 29.2 | 115 |
| t _{PHZ} | OE | В | 2.4 | 32.2 | 1.9 | 13.1 | 1.7 | 12 | 1.3 | 10.3 | ns |
| t _{PLZ} | OL | В | 2.4 | JZ.Z | 1.9 | 13.1 | 1.7 | 12 | 1.5 | 10.5 | 115 |
| t _{PZH} | ŌĒ | А | 0.4 | 24 | 0.4 | 23.8 | 0.4 | 23.7 | 0.4 | 23.7 | ns |
| t _{PZL} | | ~ | 0.4 | 24 | 0.4 | 23.0 | 0.4 | 23.1 | 0.4 | 23.1 | 115 |
| t _{PZH} | OE | В | 1.8 | 32 | 1.6 | 16 | 1.2 | 12.6 | 0.9 | 10.8 | ns |
| t _{PZL} | 0L | В | 1.0 | 52 | 1.0 | 10 | 1.2 | 12.0 | 0.9 | 10.0 | 115 |

Switching Characteristics

 $T_A = -55^{\circ}C$ to $125^{\circ}C$, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.8 V ± 0.15 V | V _{CCB} = 2.5 V ± 0.2 V | V _{CCB} = 3.3 V ± 0.3 V | V _{CCB} = 5 V ± 0.5 V | UNIT |
|------------------|-----------------|----------------|--------------------------------------|-------------------------------------|-------------------------------------|-----------------------------------|------|
| | (INFUT) | (001901) | MIN MAX | MIN MAX | MIN MAX | MIN MAX | |
| t _{PLH} | - A | В | 25.9 | 13.2 | 11.4 | 11.1 | ns |
| t _{PHL} | ~ | D | 25.9 | 15.2 | 11.4 | 11.1 | 115 |
| t _{PLH} | В | А | 27.8 | 27.8 | 27.4 | 27.4 | ns |
| t _{PHL} | В | ~ | 27.0 | 27.0 | 27.4 | 27.4 | 115 |
| t _{PHZ} | OE | А | 33.6 | 33.4 | 33.3 | 33.2 | ns |
| t _{PLZ} | OL | A | 55.0 | 55.4 | | 55.2 | 115 |
| t _{PHZ} | OE | В | 36.2 | 17.1 | 16 | 14.3 | ns |
| t _{PLZ} | OL | D | 50.2 | 17.1 | 10 | 14.5 | 115 |
| t _{PZH} | | А | 28 | 27.8 | 27.7 | 27.7 | ns |
| t _{PZL} | 0L | ~ | 20 | 27.0 | 21.1 | 21.1 | 115 |
| t _{PZH} | OE | В | 36 | 22 | 16.6 | 14.8 | ns |
| t _{PZL} | UE | В | | 22 | 10.0 | 14.0 | 115 |

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013

www.ti.com

Switching Characteristics

 $T_A = -40^{\circ}C$ to 85°C, $V_{CCA} = 2.5 V \pm 0.2 V$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM | TO | | V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | V _{CCB} = 5 V 0.5 V | |
|------------------|---------|----------|-----|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|---------------------------------|-----|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | - A | В | 1.6 | 21.4 | 1.2 | 9 | 0.8 | 6.2 | 0.6 | 4.8 | ns |
| t _{PHL} | ~ | D | 1.0 | 21.4 | 1.2 | 5 | 0.0 | 0.2 | 0.0 | 4.0 | 115 |
| t _{PLH} | - В | А | 1.2 | 9.3 | 1 | 9.1 | 1 | 8.9 | 0.9 | 8.8 | ns |
| t _{PHL} | В | A | 1.2 | 9.5 | 1 | 9.1 | 1 | 0.9 | 0.9 | 0.0 | 115 |
| t _{PHZ} | OE | А | 1.4 | 9 | 1.4 | 9 | 1.4 | 9 | 1.4 | 9 | ns |
| t _{PLZ} | 0L | ~ | 1.4 | 3 | 1.4 | 5 | 1.4 | 3 | 1.4 | 3 | 115 |
| t _{PHZ} | OE | В | 2.3 | 29.6 | 1.8 | 11 | 1.7 | 9.3 | 0.9 | 6.9 | ns |
| t _{PLZ} | UL | В | 2.5 | 29.0 | 1.0 | 11 | 1.7 | 9.5 | 0.9 | 0.9 | 115 |
| t _{PZH} | | А | 1 | 10.9 | 1 | 10.9 | 1 | 10.9 | 1 | 10.9 | ns |
| t _{PZL} | ÛE | A | 1 | 10.9 | 1 | 10.9 | 1 | 10.9 | I | 10.9 | 115 |
| t _{PZH} | | В | 1.7 | 28.2 | 1.6 | 12.9 | 1.2 | 9.4 | 1 | 6.9 | ns |
| t _{PZL} | UL UL | В | 1.7 | 20.2 | 1.0 | 12.9 | 1.2 | 9.4 | 1 | 0.9 | 115 |

Switching Characteristics

 $T_A = -55^{\circ}C$ to $125^{\circ}C$, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = 1.8 V ± 0.15 V | V _{CCB} = 2.5 V ± 0.2 V | V _{CCB} = 3.3 V ± 0.3 V | V _{CCB} = 5 V 0.5 V | UNIT |
|------------------|-----------------|----------------|--------------------------------------|-------------------------------------|-------------------------------------|---------------------------------|------|
| | (INPUT) | (001901) | MIN MAX | MIN MAX | MIN MAX | MIN MAX | |
| t _{PLH} | A | В | 25.4 | 13 | 10.2 | 8.8 | ns |
| t _{PHL} | ~ | В | 25.4 | 13 | 10.2 | 0.0 | 115 |
| t _{PLH} | В | А | 13.3 | 13.1 | 12.9 | 12.8 | ns |
| t _{PHL} | D | A | 13.3 | 13.1 | 12.9 | 12.0 | 115 |
| t _{PHZ} | OE | А | 13 | 13 | 13 | 13 | ns |
| t _{PLZ} | UE | A | 15 | 13 | 15 | 15 | 115 |
| t _{PHZ} | OE | В | 33.6 | 14 | 14.3 | 10.9 | ns |
| t _{PLZ} | UE | В | 33.0 | 14 | 14.5 | 10.9 | 115 |
| t _{PZH} | OE | А | 14.9 | 14.9 | 14.9 | 14.9 | 20 |
| t _{PZL} | UE | A | 14.9 | 14.9 | 14.9 | 14.9 | ns |
| t _{PZH} | OE | В | 32.2 | 16.9 | 13.4 | 10.9 | 20 |
| t _{PZL} | UE | D | 32.2 | 16.9 | 13.4 | 10.9 | ns |



SCES843A - JANUARY 2013 - REVISED FEBRUARY 2013

www.ti.com

Switching Characteristics

 $T_A = -40^{\circ}C$ to 85°C, $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM | TO | V _{CCB} = ± 0.7 | = 1.8 V 15 V | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | V _{CCB} = 5 V ± 0.5 V | | UNIT |
|------------------|---------|----------|-----------------------------|-----------------|-------------------------------------|------|-------------------------------------|-----|-----------------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | A | В | 1.5 | 21.2 | 1.1 | 8.8 | 0.8 | 6.1 | 0.5 | 4.4 | ns |
| t _{PHL} | ~ | D | 1.5 | 21.2 | 1.1 | 0.0 | 0.0 | 0.1 | 0.5 | 4.4 | 115 |
| t _{PLH} | В | А | 0.9 | 7.2 | 0.8 | 6.2 | 0.7 | 6.1 | 0.6 | 6 | ns |
| t _{PHL} | В | A | 0.9 | 1.2 | 0.0 | 0.2 | 0.7 | 0.1 | 0.0 | 0 | 115 |
| t _{PHZ} | OE | А | 1.6 | 8.2 | 1.6 | 8.2 | 1.6 | 6.2 | 1.6 | 8.2 | ns |
| t _{PLZ} | UL | ~ | 1.0 | 0.2 | 1.0 | 0.2 | 1.0 | 0.2 | 1.0 | 0.2 | 115 |
| t _{PHZ} | OE | В | 2.1 | 29 | 1.7 | 10.3 | 1.5 | 8.6 | 0.8 | 6.3 | ns |
| t _{PLZ} | UL UL | В | 2.1 | 29 | 1.7 | 10.5 | 1.5 | 0.0 | 0.0 | 0.5 | 115 |
| t _{PZH} | OE | А | 0.8 | 7.8 | 0.8 | 7.8 | 0.8 | 7.8 | 0.8 | 7.8 | ns |
| t _{PZL} | UE | ~ | 0.8 | 7.0 | 0.0 | 7.0 | 0.8 | 7.0 | 0.0 | 7.0 | 115 |
| t _{PZH} | OE | В | 1.6 | 27.7 | 1.4 | 12.4 | 1.1 | 8.5 | 0.9 | 8.4 | ns |
| t _{PZL} | | U U | 1.0 | 21.1 | 1.4 | 12.4 | 1.1 | 0.0 | 0.9 | 0.4 | 113 |

Switching Characteristics

 $T_A = -55^{\circ}C$ to $125^{\circ}C$, $V_{CCA} = 3.3$ V ± 0.3 V (unless otherwise noted) (see Figure 2)

| | , 00A | | , (| U , | | | |
|------------------|---------|----------|--------------------------------------|-------------------------------------|-------------------------------------|-----------------------------------|------|
| PARAMETER | FROM | TO | V _{CCB} = 1.8 V ± 0.15 V | V _{CCB} = 2.5 V ± 0.2 V | V _{CCB} = 3.3 V ± 0.3 V | V _{CCB} = 5 V ± 0.5 V | UNIT |
| | (INPUT) | (OUTPUT) | MIN MAX | MIN MAX | MIN MAX | MIN MAX | |
| t _{PLH} | А | В | 25.2 | 12.8 | 10.2 | 8.4 | ns |
| t _{PHL} | A | В | 23.2 | 12.0 | 10.2 | 0.4 | 115 |
| t _{PLH} | В | А | 11.2 | 10.2 | 10.1 | 10 | ns |
| t _{PHL} | В | A | | 10.2 | 10.1 | | 115 |
| t _{PHZ} | ŌĒ | А | 12.2 | 12.2 | 12.2 | 12.2 | ns |
| t _{PLZ} | OL | ~ | 12.2 | 12.2 | 12.2 | 12.2 | 115 |
| t _{PHZ} | ŌĒ | В | 33 | 14.3 | 12.8 | 10.3 | ns |
| t _{PLZ} | OL | В 33 | | 14.5 | 12.0 | 10.5 | 115 |
| t _{PZH} | ŌĒ | А | 11.0 | 12.1 | 12.1 | 12.1 | ns |
| t _{PZL} | UE . | A | A 11.8 | | 12.1 | 12.1 | 115 |
| t _{PZH} | ŌĒ | в | 31 7 | 16.4 | 12.9 | 10.4 | ns |
| t _{PZL} | UL | B 31.7 | | 10.4 | 12.9 | 10.4 | 115 |

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013

www.ti.com

Switching Characteristics

 $T_A = -40^{\circ}C$ to 85°C, $V_{CCA} = 5 V \pm 0.5 V$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTBUT) | TO (OUTPUT) | | V _{CC} = ± 0.2 | | | | UNIT | | |
|------------------|-----------------|----------------|----------------|------|----------------------------|------|-----|-----|------|-----|-----|
| | (INFUT) | (001101) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{PLH} | A | В | 16 | 21.4 | 1 | 8.8 | 0.7 | 6 | 0.4 | 4.2 | ns |
| t _{PHL} | ~ | D | 1.0 | 21.4 | I | 0.0 | 0.7 | 0 | 0.4 | 4.2 | 115 |
| t _{PLH} | в | А | 0.7 | 6.8 | 0.4 | 4.8 | 0.3 | 4.5 | 0.3 | 4.3 | ns |
| t _{PHL} | В | ~ | 0.7 | 0.0 | 0.4 | 4.0 | 0.3 | 4.5 | 0.3 | 4.5 | 115 |
| t _{PHZ} | ŌĒ | А | 0.3 | 5.4 | 0.3 | 5.4 | 0.3 | 5.4 | 0.3 | 6.4 | ns |
| t _{PLZ} | 0L | ~ | 0.5 | 5.4 | 0.5 | 5.4 | 0.5 | 5.4 | 0.5 | 0.4 | 115 |
| t _{PHZ} | OE | В | 2 | 28.7 | 1.6 | 9.7 | 1.4 | 8 | 0.7 | 5.7 | ns |
| t _{PLZ} | 0L | D | 2 | 20.7 | 1.0 | 5.1 | 1.4 | 0 | 0.7 | 5.7 | 115 |
| t _{PZH} | OE | А | 0.7 | 5.5 | 0.7 | 5.5 | 0.7 | 5.5 | 0.7 | 5.5 | ns |
| t _{PZL} | UL UL | ~ | 0.7 | 5.5 | 0.7 | 5.5 | 0.7 | 5.5 | 0.7 | 5.5 | 115 |
| t _{PZH} | OE | В | 1.6 | 27.6 | 1.3 | 11.4 | 1 | 8.1 | 0.9 | 6 | ns |
| t _{PZL} | UL UL | U U | 1.0 | 27.0 | 1.5 | 11.4 | I | 0.1 | 0.9 | 0 | 115 |

Switching Characteristics

 $T_A = -55^{\circ}C$ to 125°C, $V_{CCA} = 5 V \pm 0.5 V$ (unless otherwise noted) (see Figure 2)

| PARAMETER | FROM | TO (OUTBUT) | V _{CC} = 1.8 V ± 0.15 V | V _{CC} = 2.5 V ± 0.2 V | V _{CC} = 3.3 V ± 0.3 V | V _{CC} = 5 V ± 0.5 V | UNIT |
|------------------|---------|----------------|-------------------------------------|------------------------------------|------------------------------------|----------------------------------|------|
| | (INPUT) | (OUTPUT) | MIN MAX | MIN MAX | MIN MAX | MIN MAX | |
| t _{PLH} | - A | В | 25.4 | 14.3 | 10 | 8.2 | ns |
| t _{PHL} | ~ | В | 23.4 | 14.5 | 10 | 0.2 | 115 |
| t _{PLH} | в | А | 11 | 8.8 | 8.5 | 8.3 | ns |
| t _{PHL} | D | A | 11 | 0.0 | 0.5 | 0.3 | 115 |
| t _{PHZ} | OE | А | 9.4 | 9.4 | 9.4 | 9.4 | ns |
| t _{PLZ} | 0L | ~ | 5.4 | 9.4 | 5.4 | 9.4 | 115 |
| t _{PHZ} | OE | В | 32.7 | 13.7 | 12 | 9.7 | ns |
| t _{PLZ} | OL | В | 52.7 | 15.7 | 12 | 9.7 | 115 |
| t _{PZH} | OE | А | 10.4 | 10.4 | 10.4 | 10.4 | ns |
| t _{PZL} | UE | A | 10.4 | 10.4 | 10.4 | 10.4 | 115 |
| t _{PZH} | OE | В | 31.6 | 19.3 | 12.6 | 10 | ns |
| t _{PZL} | UE | D | 51.0 | 19.5 | 12.0 | 10 | 115 |

Operating Characteristics

 $T_A = 25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | V _{CCA} = V _{CCB} = 1.8 V TYP | V _{CCA} = V _{CCB} = 2.5 V TYP | V _{CCA} = V _{CCB} = 3.3 V TYP | V _{CCA} = V _{CCB} = 5 V TYP | UNIT | |
|---------------------------------|-----------------------------|--|---|---|---|---|------|--|
| c (1) | A-port input, B-port output | | 2 | 2 | 2 | 3 | | |
| C _{pdA} ⁽¹⁾ | B-port input, A-port output | $C_{L} = 0,$ | 18 | 19 | 19 | 22 | - 5 | |
| c (1) | A-port input, B-port output | f = 10 MHz, $t_r = t_f = 1 \text{ ns}$ | 18 | 19 | 20 | 22 | рF | |
| C _{pdB} ⁽¹⁾ | B-port input, A-port output | | 2 | 2 | 2 | 2 | | |

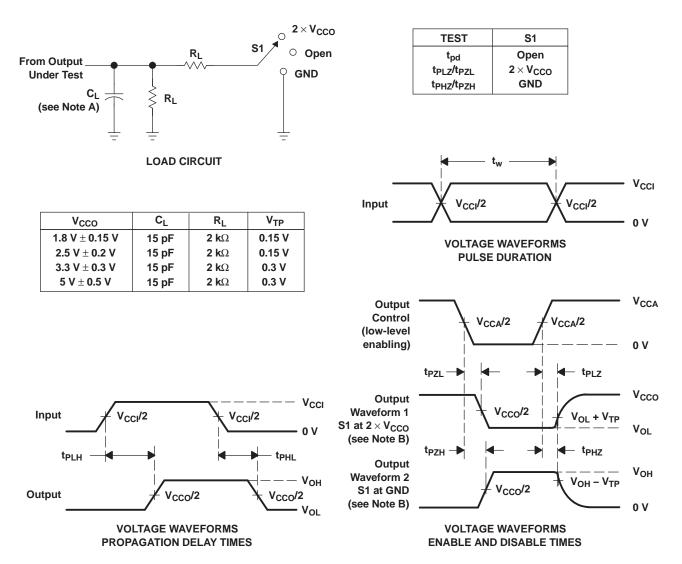
(1) Power dissipation capacitance per transceiver



SN74LVC16T245-EP

SCES843A – JANUARY 2013 – REVISED FEBRUARY 2013

www.ti.com



PARAMETER MEASUREMENT INFORMATION

NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \le 10$ MHz, $Z_O = 50 \Omega$, $dv/dt \ge 1$ V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.
- J. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms



PACKAGING INFORMATION

| Orderable Device | Status | Package Type | Package Drawing | Pins | Package Qty | | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking | Samples |
|-------------------|--------|--------------|--------------------|------|----------------|--------------|-------------------------------|--------------------|--------------|----------------|---------|
| | (1) | | Drawing | | uly | (2) | (6) | (3) | | (4/5) | |
| CLVC16T245MDGGEP | ACTIVE | TSSOP | DGG | 48 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | LVC16T245M | Samples |
| CLVC16T245MDGGREP | ACTIVE | TSSOP | DGG | 48 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | LVC16T245M | Samples |
| V62/12667-01XE | ACTIVE | TSSOP | DGG | 48 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | LVC16T245M | Samples |
| V62/12667-01XE-T | ACTIVE | TSSOP | DGG | 48 | 40 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -55 to 125 | LVC16T245M | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and



10-Dec-2020

continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

OTHER QUALIFIED VERSIONS OF SN74LVC16T245-EP :

• Catalog: SN74LVC16T245

NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product

PACKAGE MATERIALS INFORMATION

Texas Instruments

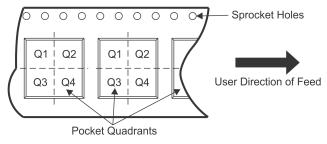
www.ti.com

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



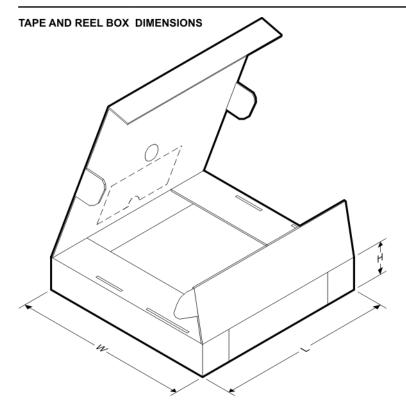
| *All dimensions are nominal | |
|-----------------------------|--|
|-----------------------------|--|

| Device | • | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|-------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CLVC16T245MDGGREP | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |



PACKAGE MATERIALS INFORMATION

5-Jan-2022



*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CLVC16T245MDGGREP | TSSOP | DGG | 48 | 2000 | 367.0 | 367.0 | 45.0 |



5-Jan-2022

TUBE



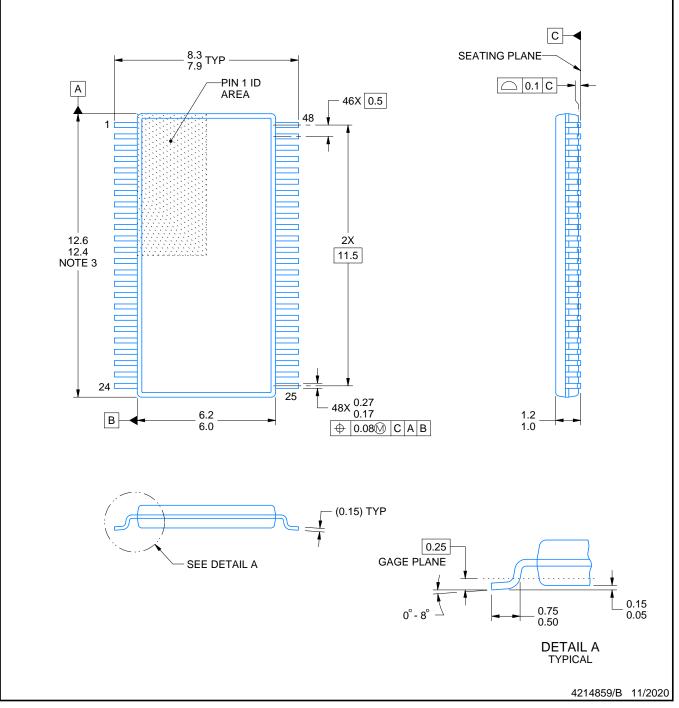
*All dimensions are nominal

| Device | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|------------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CLVC16T245MDGGEP | DGG | TSSOP | 48 | 40 | 530 | 11.89 | 3600 | 4.9 |
| V62/12667-01XE-T | DGG | TSSOP | 48 | 40 | 530 | 11.89 | 3600 | 4.9 |

PACKAGE OUTLINE

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
 This drawing is subject to change without notice.
 This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not

- exceed 0.15 mm per side. 4. Reference JEDEC registration MO-153.



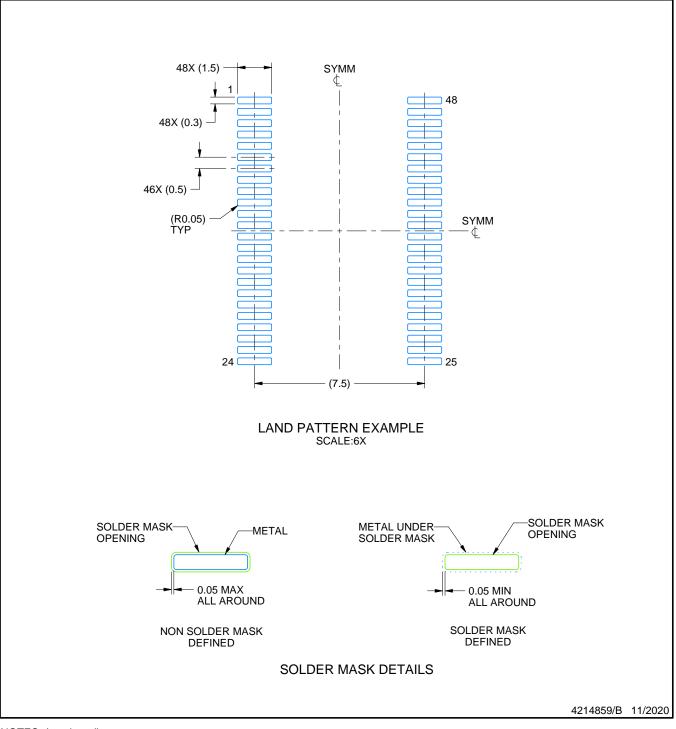
DGG0048A

DGG0048A

EXAMPLE BOARD LAYOUT

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.

6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

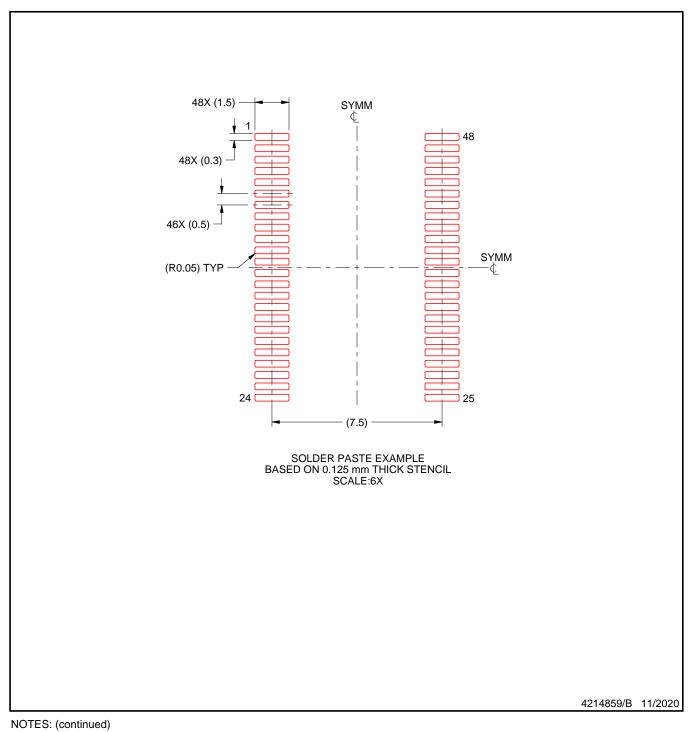


DGG0048A

EXAMPLE STENCIL DESIGN

TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate

design recommendations. 8. Board assembly site may have different recommendations for stencil design.



MECHANICAL DATA

MTSS003D - JANUARY 1995 - REVISED JANUARY 1998

DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2022, Texas Instruments Incorporated